Notebook LCD Panel EMI Reduction IC

Features

- FCC approved method of EMI attenuation
- Generates a low EMI spread spectrum of the input clock frequency
- Optimized for frequency range: P1727X: 20MHz to 40MHz
- Internal loop filter minimizes external components and board space
- 8 different frequency deviations ranging from ±0.625% to –3.50%
- Low inherent Cycle-to-cycle jitter
- 3.3V Operating Voltage
- Supports notebook VGA and other LCD timing controller applications
- Available in 8-pin SOIC.

Product Description

The P1727 is a versatile spread spectrum frequency modulator designed specifically for a wide range of clock frequencies. The P1727 reduces electromagnetic interference (EMI) at the clock source, allowing system wide reduction of EMI of down stream (clock and data dependent signals). The P1727 allows significant system cost savings by reducing the number of circuit board layers and shielding that are traditionally required to pass EMI regulations.
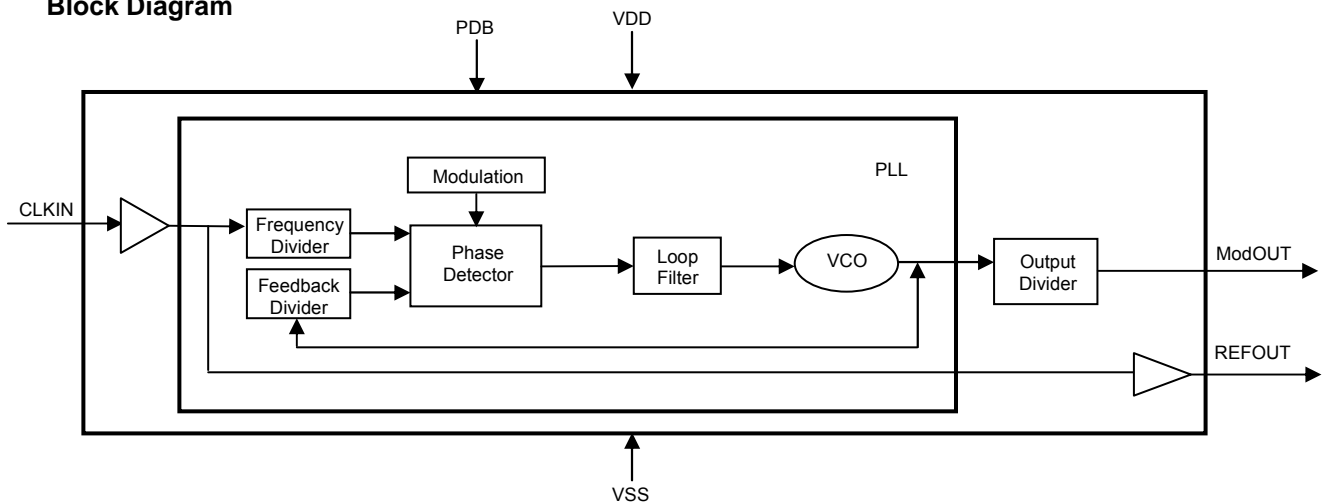
The P1727 modulates the output of a single PLL in order to "spread" the bandwidth of a synthesized clock, thereby decreasing the peak amplitudes of its harmonics. This result in significantly lower system EMI compared to the typical narrow band signal produced by oscillators and most clock generators. Lowering EMI by increasing a signal's bandwidth is called spread spectrum clock generation.

The P1727 uses the most efficient and optimized modulation profile approved by the FCC and is implemented by using a proprietary all-digital method.

Applications

The P1727 is targeted towards notebook LCD displays, other displays using an LVDS interface, PC peripheral devices and embedded systems.
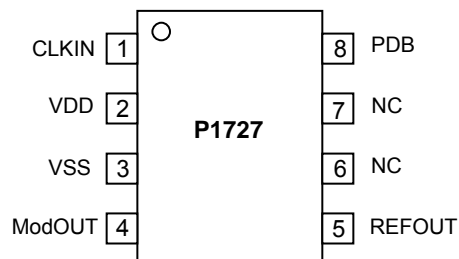
Block Diagram

Pin Configuration

```
        CLKIN  1 ○        8  PDB
        VDD    2           7  NC
                P1727
        VSS    3           6  NC

        ModOUT 4           5  REFOUT
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Table 1 – Power Down Selection

PDB	Spread Spectrum	ModOUT	PLL	Mode
0	N/A	Disabled	Disabled	Power Down
1	ON	Normal	Normal	Normal

Table 2 – Frequency Deviation Selection

P/ N	Deviation	P/N	Deviation
P1727A	-1.25%	P1727E	±0.625%
P1727B	-1.75%	P1727F	±0.875%
P1727C	-2.50%	P1727G	±1.25%
P1727D	-3.50%	P1727H	±1.75%

Pin Description

Pin#	Pin Name	Type	Description
1	CLKIN	I	External reference frequency input. Connect to externally generated reference signal.
2	VDD	P	Connect to +3.3V.
3	VSS	P	Ground Connection. Connect to system ground.
4	ModOUT	O	Spread Spectrum Clock output.
5	REFOUT	O	Reference output.
6	NC		No connect.
7	NC		No connect.
8	PDB	I	Powerdown Pin. Pull low to disable spread spectrum clock output.

Schematic for notebook VGA application

27MHz Pixel Clock input → 1 CLKIN | P1727 | PDB 8 → Tie low to enable Powerdown mode.

VDD

2 VDD — NC 7

0.1 µF

3 VSS — NC 6

ModOut Clock — 4 ModOUT — REFOUT 5 → Reference Clock O/P
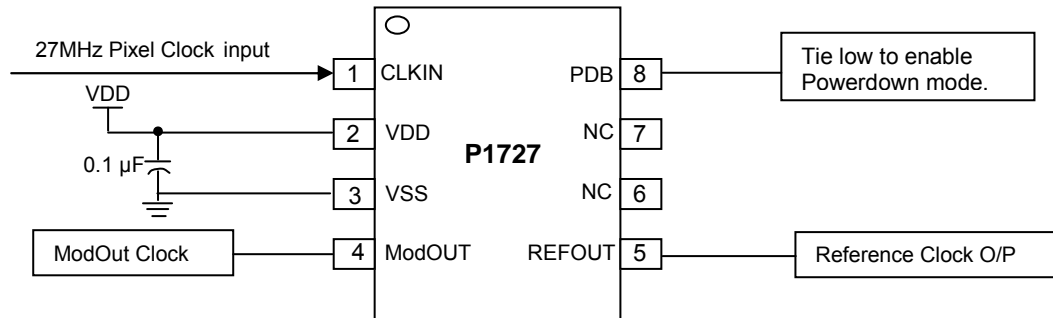
Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit
VDD, V_{IN}	Voltage on any pin with respect to Ground	-0.5 to +7	V
T_{STG}	Storage temperature	-65 to +125	℃
T_s	Max. Soldering Temperature (10 sec)	260	℃
T_J	Junction Temperature	150	℃
T_{DV}	Static Discharge Voltage (As per JEDEC STD22- A114-B)	2	KV
Note: These are stress ratings only and are not implied for functional use. Exposure to absolute maximum ratings for prolonged periods of time may affect device reliability.			

Operating Conditions

Symbol	Parameter	Min	Max	Unit
VDD	Supply Voltage with respect to VSS	3.0	3.6	V
T_A	Operating temperature	-40	+85	℃
C_L	Load Capacitance		15	pF
C_{IN}	Input Capacitance		7	pF

DC Electrical Characteristics

Symbol	Parameter		Min	Typ	Max	Unit
V_{IL}	Input Low voltage		VSS – 0.3		0.8	V
V_{IH}	Input High voltage		2.0		VDD +0.3	V
I_{IL}	Input Low current				-35	µA
I_{IH}	Input High current				35	µA
V_{OL}	Output Low current	VDD = 3.3V, I_{OL} = 20mA			0.4	V
V_{OH}	Output High current	VDD = 3.3V, I_{OH} = 20mA	2.5			V
I_{DD}	Static Supply Current (CLKIN, PDB pulled Low)				2	mA
I_{CC}	Dynamic Supply Current (No Load)			14	18	mA
V_{DD}	Operating Voltage		3.0	3.3	3.6	V
t_{ON}	Power up time (first locked clock cycle after power up)			0.18		mS
Z_{OUT}	Clock Output impedance			50		Ω

AC Electrical Characteristics

Symbol	Parameter		Min	Typ	Max	Unit
f_{IN}	Input Frequency:	P1727X	20		40	MHz
f_{OUT}	Output Frequency:	P1727X	20		40	MHz
t_{LH}[1]	Output Rise time	Measured from 0.8V to 2.0V	0.7	0.9	1.1	nS
t_{HL}[1]	Output Fall time	Measured from 2.0V to 0.8V	0.6	0.8	1.0	nS
t_{JC}	Jitter (Cycle-to-cycle)			225	325	pS
t_D	Output Duty cycle		45	50	55	%
Note: 1. t_{LH} and t_{HL} are measured with a capacitive load of 15pF.						

Package Information

8-lead (150-mil) SOIC Package
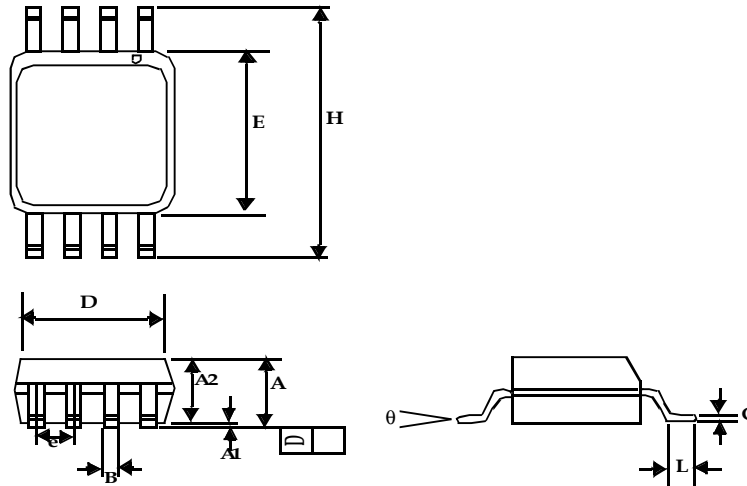
Symbol	Dimensions			
	Inches		Millimeters	
	Min	Max	Min	Max
A1	0.004	0.010	0.10	0.25
A	0.053	0.069	1.35	1.75
A2	0.049	0.059	1.25	1.50
B	0.012	0.020	0.31	0.51
C	0.007	0.010	0.18	0.25
D	0.193 BSC		4.90 BSC	
E	0.154 BSC		3.91 BSC	
e	0.050 BSC		1.27 BSC	
H	0.236 BSC		6.00 BSC	
L	0.016	0.050	0.41	1.27
θ	0°	8°	0°	8°

Ordering Information

Part number	Marking	Package Configuration	Temperature Range
P1727AF-08SR	ABW	8-PIN SOIC, TAPE & REEL, Green	0℃ to +70℃

A "microdot" placed at the end of last row of marking or just below the last row toward the center of package indicates Pb-free.